

TOSHIBA Photocoupler GaAs Ired & Photo-Thyristor

TLP541G, TLP542G

Programmable Controllers

AC-Output Module

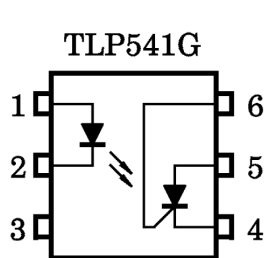
Solid State Relay

The TOSHIBA TLP541G consists of a photo-thyristor optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

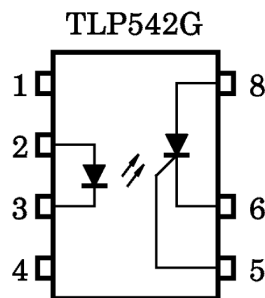
The TOSHIBA TLP542G consists of a photo-thyristor optically coupled to a gallium arsenide infrared emitting diode in a seven lead plastic DIP package.

- Peak off-state voltage: 400 V (min.)
- Trigger LED current: 7 mA (max.)
- On-state current: 150 mA (max.)
- Isolation voltage: 2500 V_{rms} (min.)
- UL recognized: UL1577, file no. E67349

Pin Configuration (top view)

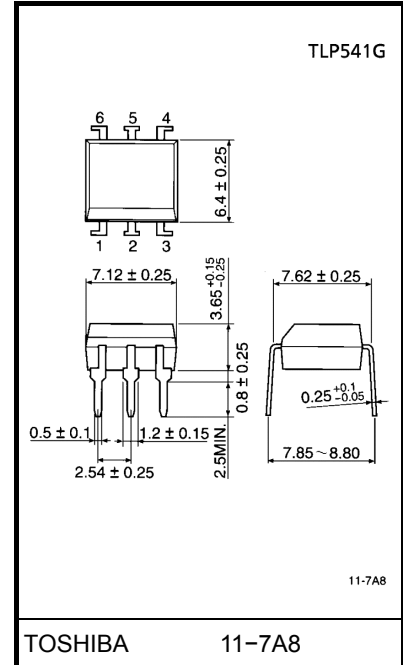


- 1 : ANODE
- 2 : CATHODE
- 3 : N.C.
- 4 : CATHODE
- 5 : ANODE
- 6 : GATE

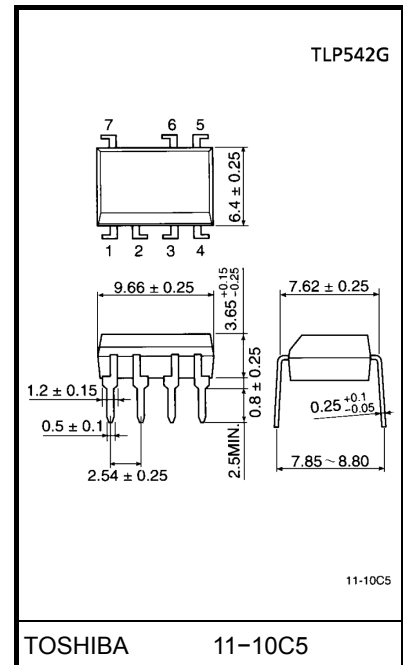


- 1 : N.C.
- 2 : ANODE
- 3 : CATHODE
- 4 : N.C.
- 5 : GATE
- 6 : CATHODE
- 7 : ANODE

Unit in mm



Weight: 0.4 g



Weight: 0.53 g

Maximum Ratings (Ta = 25°C)

| Characteristic | | Symbol | Rating | Unit |
|---|--|-------------------------------|---------|-----------|
| LED | Forward current | I_F | 70 | mA |
| | Forward current derating (Ta ≥ 25°C) | $\Delta I_F / ^\circ\text{C}$ | -0.7 | mA / °C |
| | Peak forward current (100 μs pulse, 100 pps) | I_{FP} | 1 | A |
| | Reverse voltage | V_R | 5 | V |
| | Junction temperature | T_j | 125 | °C |
| Detector | Peak forward voltage (RGK = 27kΩ) | V_{DRM} | 400 | V |
| | Peak reverse voltage (RGK = 27kΩ) | V_{RRM} | 400 | V |
| | On-state current | I_T (RMS) | 150 | mA |
| | On-state current derating (Ta ≥ 25°C) | $\Delta I_T / ^\circ\text{C}$ | -2.0 | mA / °C |
| | Peak one cycle surge current | I_{TSM} | 2 | A |
| | Peak reverse gate voltage | V_{GM} | -5 | V |
| | Junction temperature | T_j | 100 | °C |
| Storage temperature range | | T_{stg} | -55~125 | °C |
| Operating temperature range | | T_{opr} | -30~100 | °C |
| Lead soldering temperature (10 s) | | T_{sol} | 260 | °C |
| Isolation voltage (AC, 1 min., R.H. ≤ 60%) (Note) | | BV_S | 2500 | V_{rms} |

(Note) Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

Recommended Operating Conditions

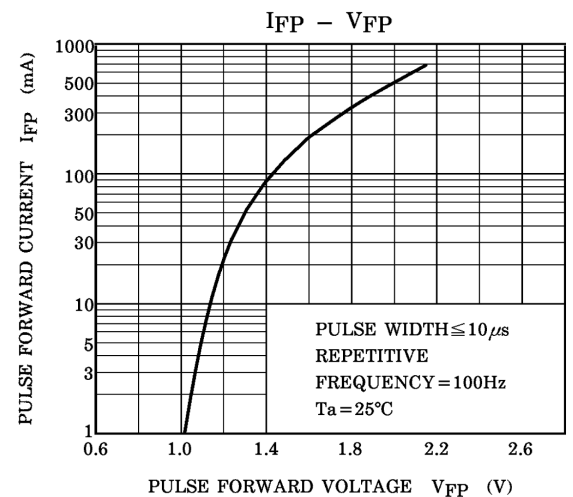
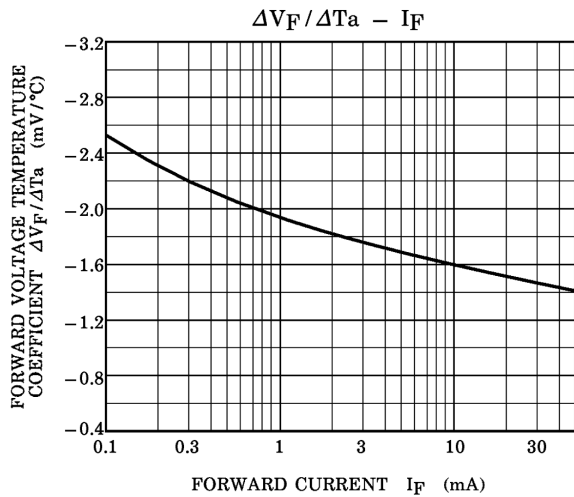
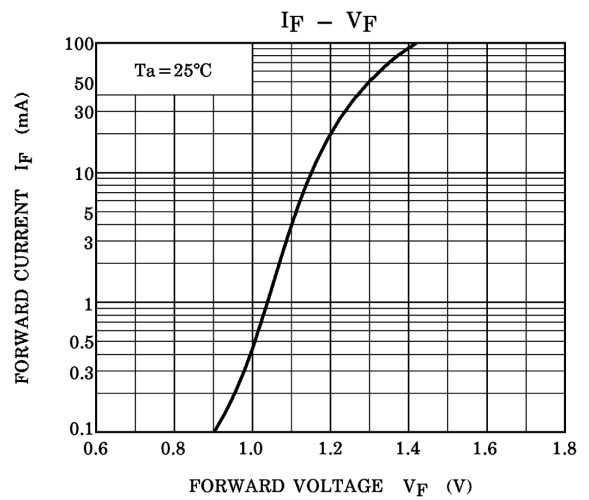
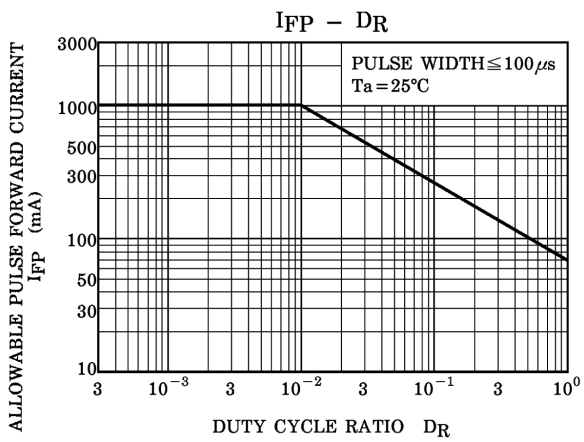
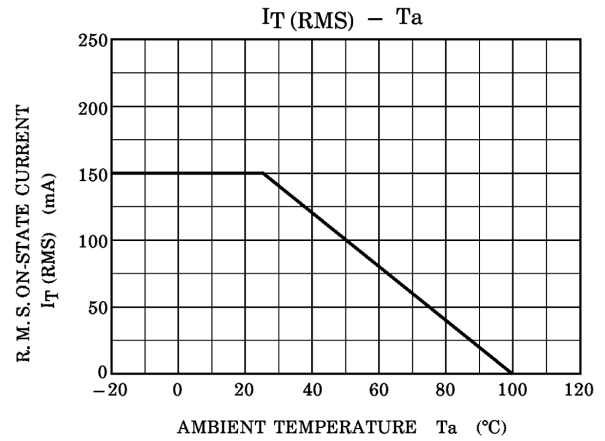
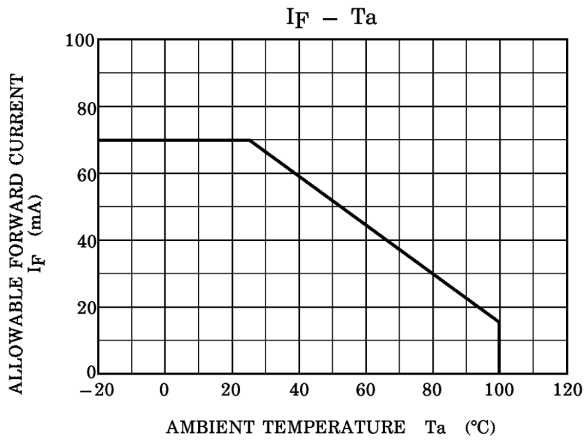
| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|----------------------------|-----------|------|------|------|----------|
| Supply voltage | V_{AC} | — | — | 120 | V_{ac} |
| Forward current | I_F | 10 | 16 | 25 | mA |
| Operating temperature | T_{opr} | -30 | — | 85 | °C |
| Gate to cathode resistance | R_{GK} | — | 27 | 33 | kΩ |
| Gate to cathode capacity | C_{GK} | — | 0.01 | 0.1 | μF |

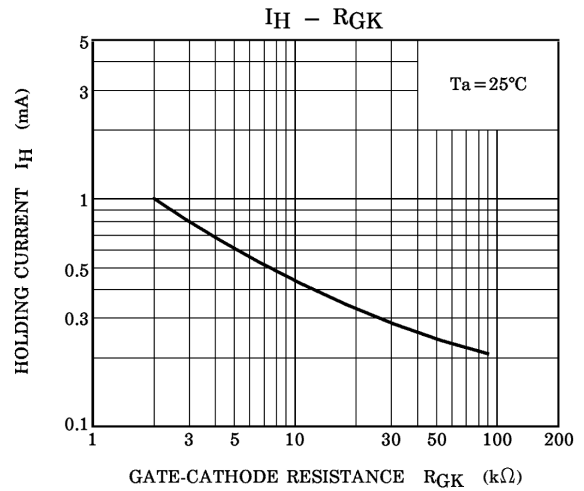
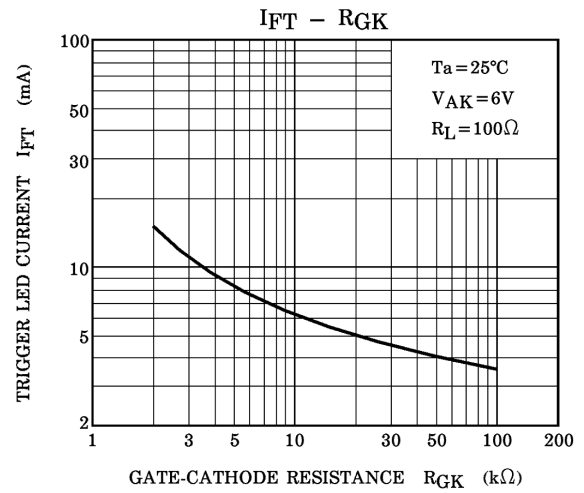
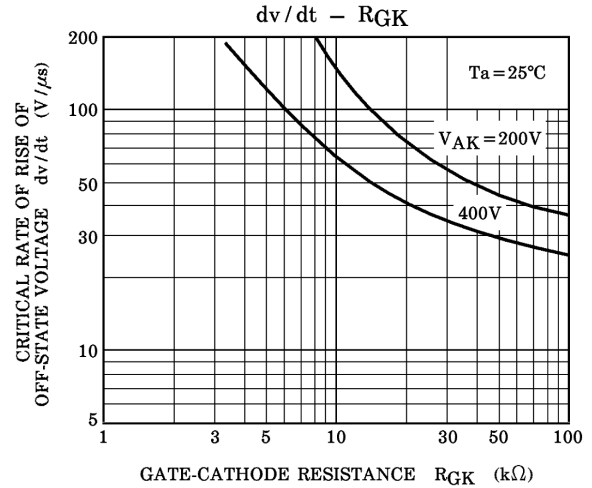
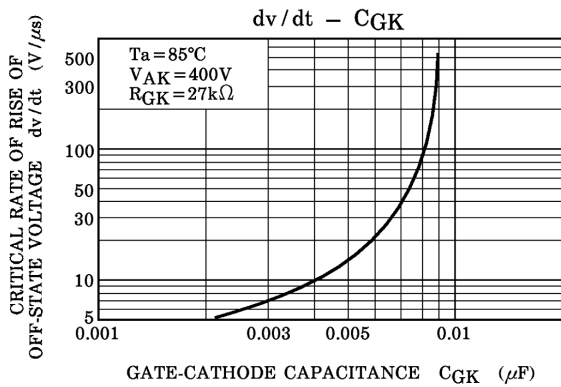
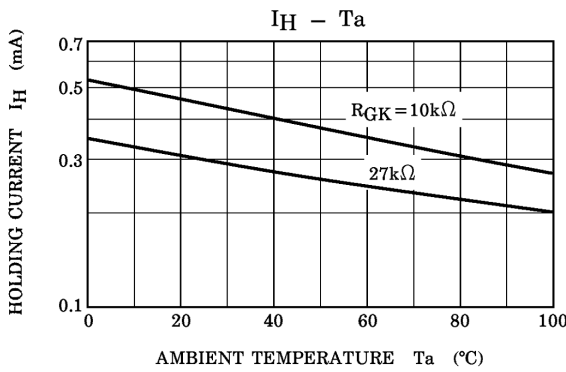
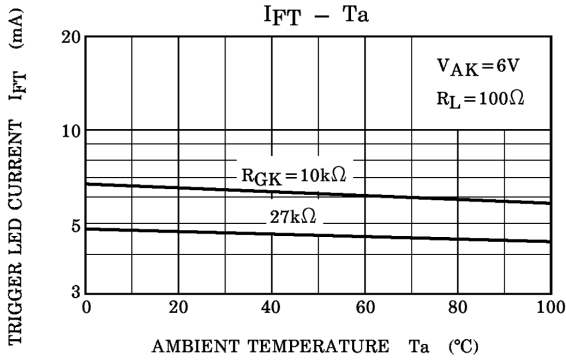
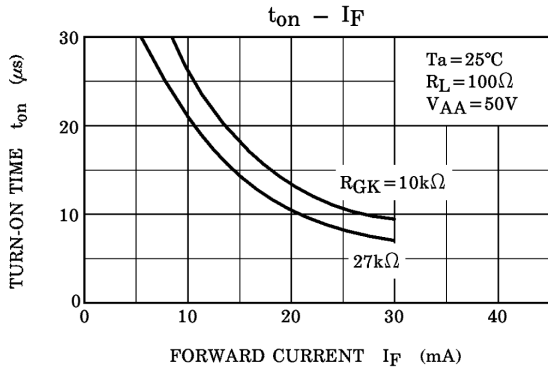
Individual Electrical Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | Min. | Typ. | Max. | Unit | |
|----------------|-------------------|----------------------------|---|------------|------|------|------------------|---------------|
| LED | Forward voltage | V_F | $I_F = 10 \text{ mA}$ | 1.0 | 1.15 | 1.3 | V | |
| | Reverse current | I_R | $V_R = 5 \text{ V}$ | — | — | 10 | μA | |
| | Capacitance | C_T | $V = 0, f = 1 \text{ MHz}$ | — | 30 | — | pF | |
| Detector | Off-state current | I_{DRM} | $V_{AK} = 400 \text{ V}$ $R_{GK} = 27 \text{ k}\Omega$ | Ta = 25°C | — | 10 | 5000 | nA |
| | | | | Ta = 100°C | — | 1 | 100 | μA |
| | Reverse current | I_{RRM} | $V_{KA} = 400 \text{ V}$ $R_{GK} = 27 \text{ k}\Omega$ | Ta = 25°C | — | 10 | 5000 | nA |
| | | | | Ta = 100°C | — | 1 | 100 | μA |
| | On-state voltage | V_{TM} | $I_{TM} = 100 \text{ mA}$ | — | 0.9 | 1.3 | V | |
| | Holding current | I_H | $R_{GK} = 27 \text{ k}\Omega$ | — | 0.2 | 1 | mA | |
| | Off-state dv/dt | dv/dt | $V_{AK} = 280 \text{ V}, R_{GK} = 27 \text{ k}\Omega$ | 5 | 10 | — | V/ μs | |
| Capacitance | C_j | $V = 0, f = 1 \text{ MHz}$ | Anode to gate | — | 20 | — | pF | |
| | | | Gate to cathode | — | 350 | — | | |

Coupled Characteristics (Ta = 25°C)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|-------------------------------|----------|---|------|-----------|------|---------------|
| Trigger LED current | I_{FT} | $V_{AK} = 6 \text{ V}, R_{GK} = 27 \text{ k}\Omega$ | 1 | 4 | 7 | mA |
| Turn-on time | t_{on} | $I_F = 50 \text{ mA}, R_{GK} = 27 \text{ k}\Omega$ | — | 10 | — | μs |
| Capacitance (input to output) | C_S | $V_S = 0, f = 1 \text{ MHz}$ | — | 0.8 | — | pF |
| Isolation resistance | R_S | $V_S = 500 \text{ V}, \text{R.H.} \leq 60\%$ | — | 10^{11} | — | Ω |
| Isolation voltage | BV_S | AC, 1 minute | 2500 | — | — | V_{rms} |





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